## imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





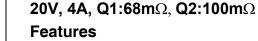
Is Now Part of



## **ON Semiconductor**®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconduc



FAIRCHILD SEMICONDUCTOR

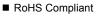
FDMC6890NZ

Q1: N-Channel

- Max  $r_{DS(on)}$  = 68m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 4A
- Max  $r_{DS(on)}$  = 100m $\Omega$  at  $V_{GS}$  = 2.5V,  $I_D$  = 3A

Q2: N-Channel

- Max  $r_{DS(on)}$  = 100m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 4A
- Max  $r_{DS(on)}$  = 150m $\Omega$  at V<sub>GS</sub> = 2.5V, I<sub>D</sub> = 2A
- Low gate Charge





**Dual N-Channel PowerTrench<sup>®</sup> MOSFET** 

### **General Description**

FDMC6890NZ is a compact single package solution for DC to DC converters with excellent thermal and switching characteristics. Inside the Power 33 package features two N-channel MOSFETs with low on-state resistance and low gate charge to maximize the power conversion and switching efficiency. The Q1 switch also integrates gate protection from unclamped voltage input.

#### Application

DC - DC Conversion

# Up Bottom S1 D1/S2 D2 G1 D1/S2 G2 D2G1 D1/S2 G2 D1/S2 D1/S2

#### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V <sub>DS</sub>	Drain to Source Voltage		20	20	V
V <sub>GS</sub>	Gate to Source Voltage		±12	±12	V
I <sub>D</sub>	-Continuous		4		Α
	-Pulsed		1	10	
-	Power Dissipation (Steady State) Q1	(Note 1a)	1.92		14/
P <sub>D</sub>	Power Dissipation (Steady State) Q2		1.78		W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150		°C

#### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	Q1	(Note 1a)	65	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	Q2		70	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
6890N	FDMC6890NZ	Power 33	7inch	8mm	3000 units

October 2006

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Мах	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	Q1 Q2	20 20			V
ΔΒV <sub>DSS</sub> ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$	Q1 Q2		13 12		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V	Q1 Q2			1 1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±12V, $V_{DS}$ = 0V	Q1 Q2			±10 ±100	μA nA
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	Q1 Q2	0.6 0.6	0.9 1.0	2 2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$	Q1 Q2		-3 -3		mV/°C
-	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 4A$ $V_{GS} = 2.5V, I_D = 3A$	Q1		58 77	68 100	
r <sub>DS(on)</sub>	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 4A$ $V_{GS} = 2.5V, I_D = 2A$	Q2		67 102	100 150	- mΩ
9fs	Forward Transconductance	$V_{DS} = V, I_D = 4A$	Q1 Q2		10 7		S
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f= 1MHZ	Q1 Q2		205 190	270 250	pF
C <sub>oss</sub>	Output Capacitance		Q1 Q2		60 60	80 80	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		Q1 Q2		40 35	60 55	pF
		+				1	

#### Switching Characteristics

Gate Resistance

 $\mathsf{R}_\mathsf{g}$ 

t <sub>d(on)</sub>	Turn-On Delay Time		Q1 Q2	4 4	10 10	ns
t.	Rise Time	$V_{DD}$ = 10V, $I_{D}$ = 4A, $R_{GEN}$ = 6 $\Omega$	Q1	13	22	ns
ι <sub>r</sub>		$v_{\rm DD} = 10 v, 10 = 4A, 10 GEN = 002$	Q2	12	21	
1	Turn Off Dolou Time		Q1	10	19	
t <sub>d(off)</sub>	Turn-Off Delay Time		Q2	7	14	ns
			Q1	6	12	
t <sub>f</sub>	Fall Time		Q2	6	12	ns
<u> </u>			Q1	2.4	3.4	-0
Q <sub>g(TOT)</sub>	Total Gate Charge at 4.5V	$V_{GS} = 0V$ to 4.5V	Q2	1.8	2.6	nC
0	Total Cata Charge at 21/		Q1	1.4	1.9	
Q <sub>g(2)</sub>	Total Gate Charge at 2V	V <sub>DD</sub> = 10 V I <sub>D</sub> = 4A	Q2	0.6	0.8	nC
0		$I_{\rm D} = 4A$	Q1	0.4		
Q <sub>gs</sub>	Gate to Source Gate Charge		Q2	0.5		nC
0	O sta ta Dasia "Millar" Olaraza		Q1	0.9		-0
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		Q2	0.8		nC

f = 1MHz

Q1

Q2

3.3

2.8

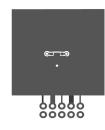
Ω

FDMC6890NZ Dual N-Channel PowerTrench<sup>®</sup> MOSFET

FDMC6890N2
NZ Dual
<b>N-Channel</b>
PowerTrench <sup>®</sup>
MOSFET

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	urce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 4A$	Q1 Q2		0.94 0.92	1.25 1.25	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 4A, di/dt = 100A/s	Q1 Q2		18 17	27 26	ns
Q <sub>rr</sub>	Reverse Recovery Charge		Q1 Q2		9 10	14 15	nC

Notes:
1: R<sub>0JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

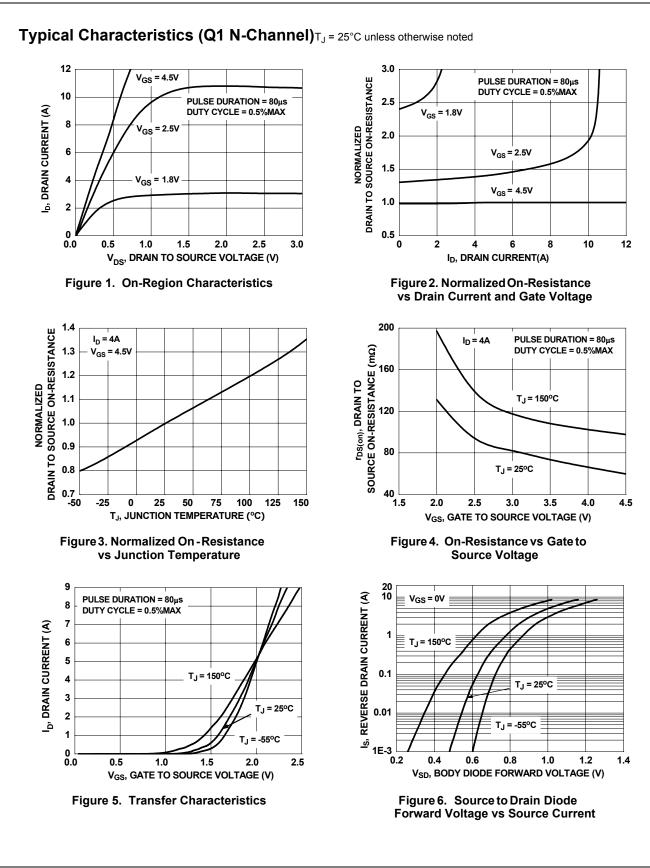


2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

a. 65°C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

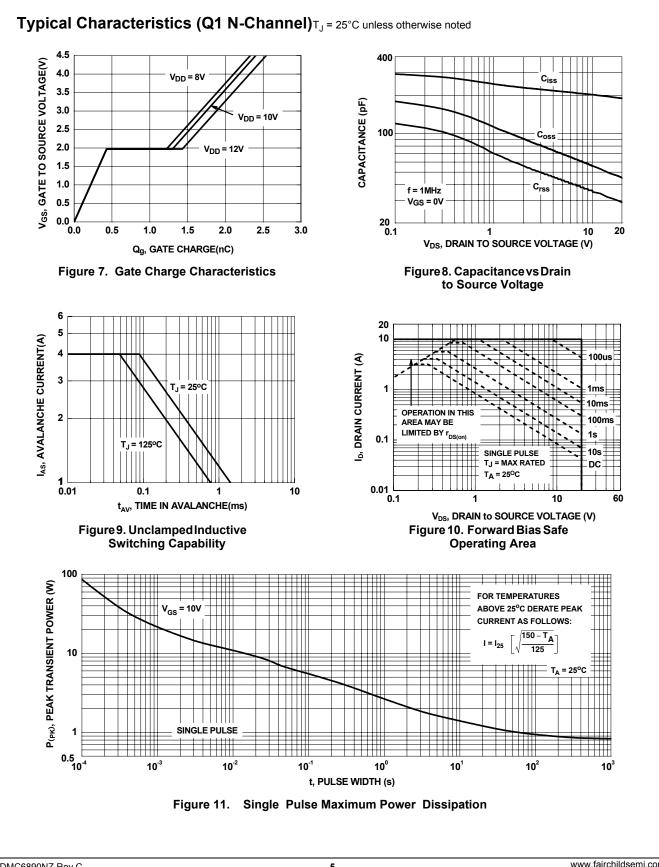
b. 150°C/W when mounted on a minimum pad of 2 oz copper





FDMC6890NZ Rev.C

4

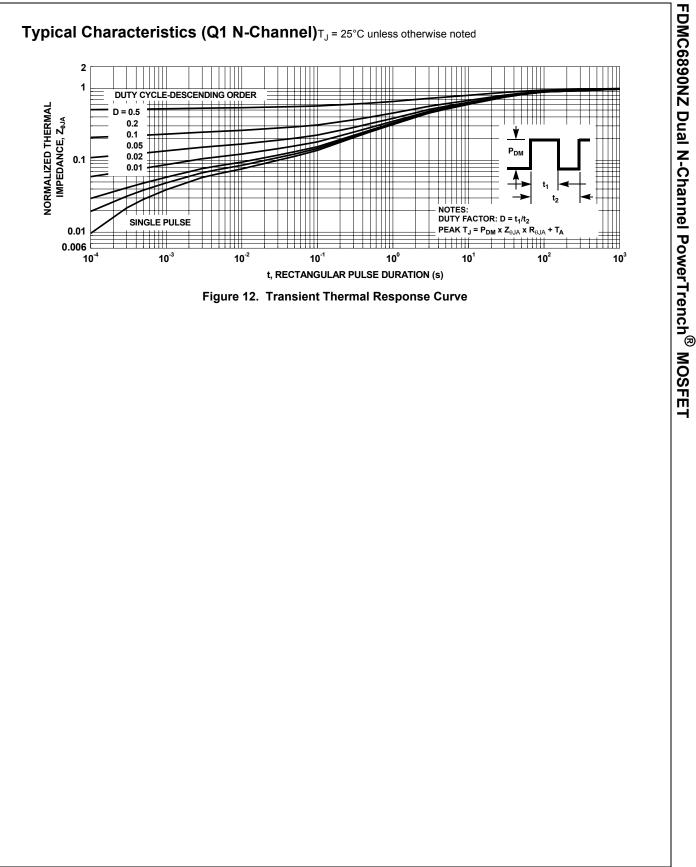


FDMC6890NZ Rev.C

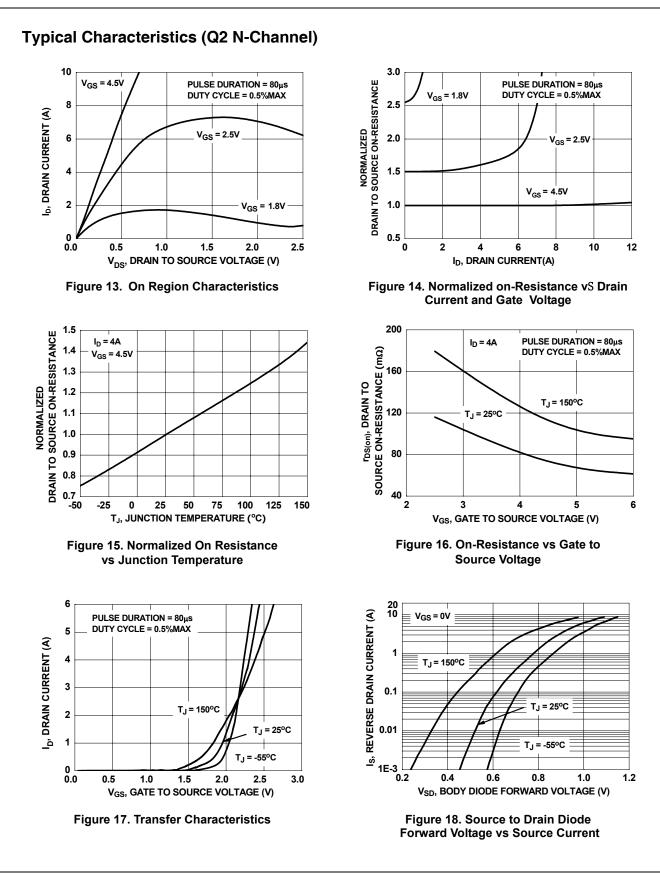
5

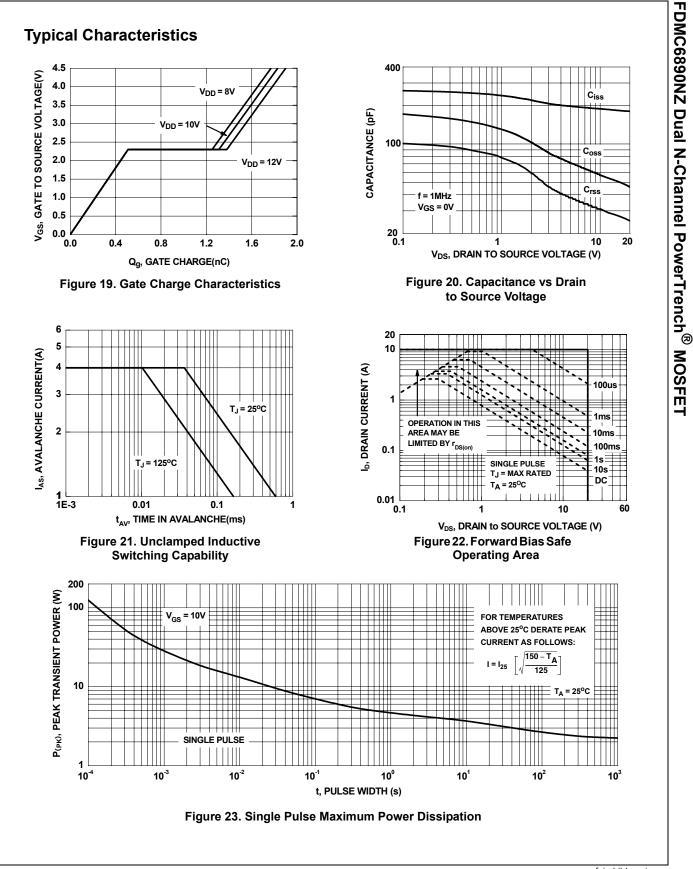
www.fairchildsemi.com

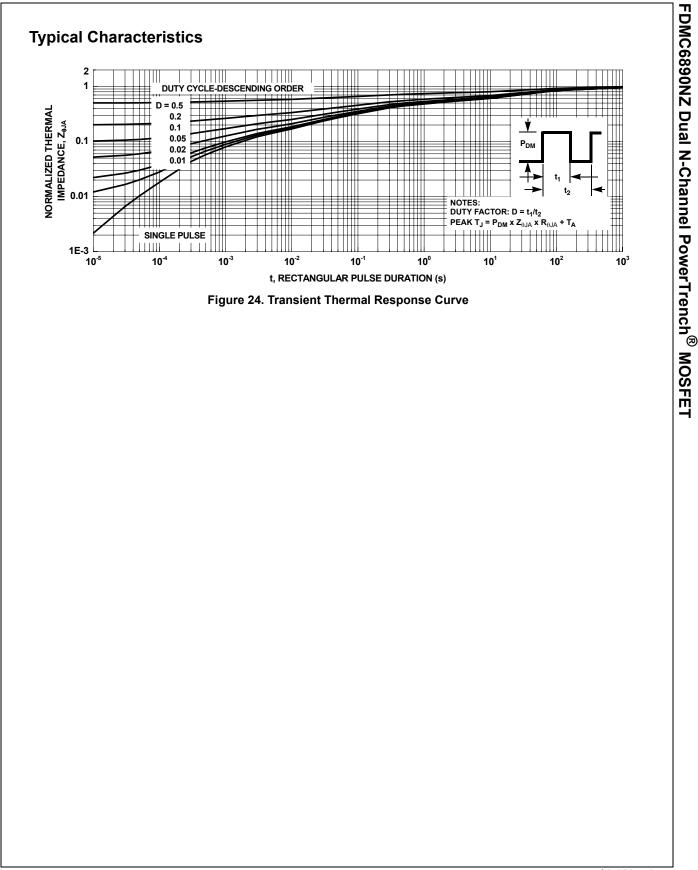
FDMC6890NZ Dual N-Channel PowerTrench<sup>®</sup> MOSFET



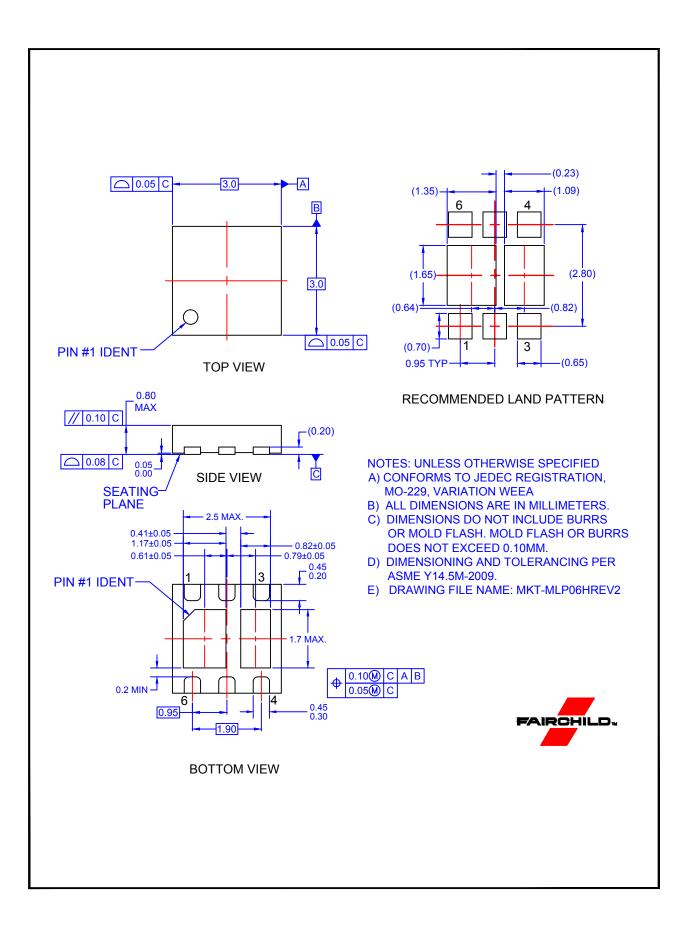
FDMC6890NZ Dual N-Channel PowerTrench<sup>®</sup> MOSFET







FDMC6890NZ Rev.C



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC